TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TD62783APA

8CH HIGH-VOLTAGE SOURCE DRIVER

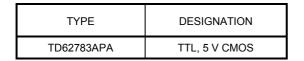
The TD62783APA is comprised of eight source current transistor array.

These drivers are specifically designed for fluorescent display applications.

Applications include relay, hammer and lamp drivers.

FEATURES

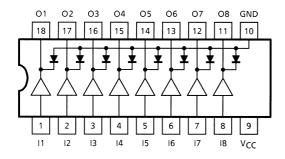
- High output voltage type–APA: $V_{CE (SUS)} = 50 \text{ V (Min)}$
- Output current (single output) : IOUT = -500 mA / ch (Max)
- Output clamp diodes
- Single supply voltage
- Input compatible with TTL, 5 V CMOS
- Package type: DIP-18 pin



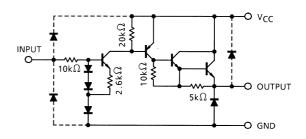
DIP18-P-300-2.54F

Weight: 1.478 g (Typ.)

PIN CONNECTION (TOP VIEW)



SCHEMATICS (EACH DRIVER)



Note: The input and output parasitic diodes cannot be used as clamp diodes.

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	V _{CC}	50	V
Output Current	lout	-500	mA / ch
Input Voltage	V _{IN}	15	٧
Clamp Diode Reverse Voltage	V _R	50	٧
Clamp Diode Forward Current	lF	500	mA
Power Dissipation	P _D (Note)	1.47	W
Operating Temperature	T _{opr}	-40~85	°C
Storage Temperature	T _{stg}	-55~150	°C

Note: Delated above 25°C in the proportion of 11.7 mW / °C.



RECOMMENDED OPERATING CONDITIONS (Ta = -40~85°C)

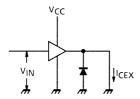
CHARACTERISTIC		SYMBOL	CONDITION	MIN	TYP.	MAX	UNIT
Supply Voltage		V _{CC}	_	_	_	50	V
Output Current		Гоит	T _{pw} = 25 ms, Duty = 8% 8 Circuits	_	_	-400	mA / ch
			T _{pw} = 25 ms, Duty = 25% 8 Circuits	-	_	-200	
Input Voltage		V _{IN}	_	_	_	12	V
Input Voltage	Output On	V _{IN (ON)}	_	2.0	5.0	15	V
	Output Off	V _{IN (OFF)}	_	0	_	0.8	V
Clamp Diode Rev	verse Voltage	V _R	_	_	_	50	V
Clamp Diode Forward Current		l _F	_	_	_	400	mA
Power Disspation	1	PD	_	_	_	0.52	W

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

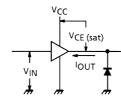
CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
Output Leakage Current	ICEX	1	$V_{CC} = V_{CC}$ MAX., $V_{IN} = 0.4$ V Ta = 25°C	_	_	100	μA
Output Saturation Voltage		2	V _{IN} = V _{IN} (ON), I _{OUT} = -350 mA	_	_	2.0	V
	V _{CE} (sat)		V _{IN} = V _{IN} (ON), I _{OUT} = -225 mA	_	_	1.9	
			V _{IN} = V _{IN} (ON), I _{OUT} = -100 mA	_	_	1.8	
Input Current	lu. casu	3	V _{IN} = 2.4 V	_	36	52	μА
	IN (ON)		V _{IN} = 3.85 V	_	180	260	
Input Voltage	V _{IN (ON)}	4	V _{CE} = 2.0 V, I _{OUT} = −350 mA	_	_	2.0	V
	V _{IN} (OFF)		I _{OUT} = -500 μA	0.8	_	_	
Supply Current	ICC (ON)	3	V _{IN} = V _{IN} (ON), V _{CC} = 50 V	_	_	2.5	mA / ch
Clamp Diode Leakage Current	I _R	5	V _R = 50 V	_	_	50	μΑ
Clamp Diode Forward Voltage	V _F	6	I _F = 350 mA	_	_	2.0	V
Turn-On Delay	t _{ON}	7	$V_{CC} = V_{CC MAX.}$, $R_L = 125 \Omega$ $C_L = 15 pF$	_	0.15	_	ше
Turn-Off Delay	toff			_	1.8	_	μs

TEST CIRCUIT

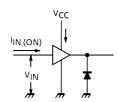
1. ICEX



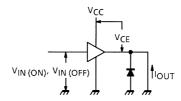
2. V_{CE (sat)}



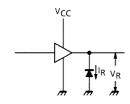
3. I_{IN (ON),} I_{CC}



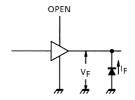
4. V_{IN (ON)}, V_{IN (OFF)}



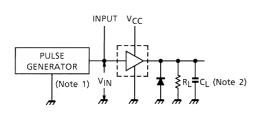
5. I_R

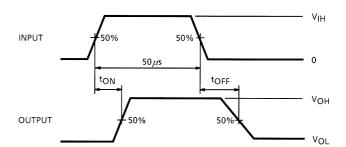


6. V_F



7. ton, toff





Note 1: Pulse Width 50 μs , Duty Cycle 10%

Output Impedance 50 Ω , $t_r \le 5$ ns, $t_f \le 10$ ns

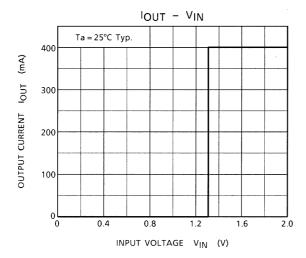
Note 2: C_L includes probe and jig capacitance.

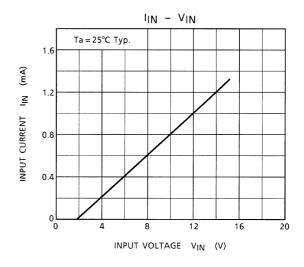
PRECAUTIONS for USING

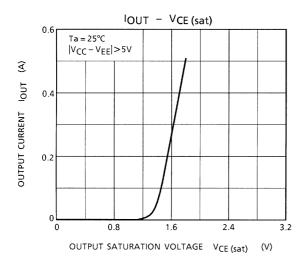
This IC does not integrate protection circuits such as overcurrent and overvoltage protectors.

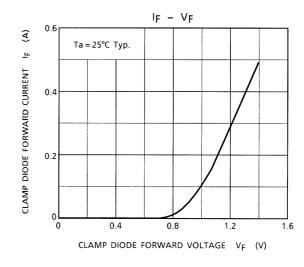
Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC.

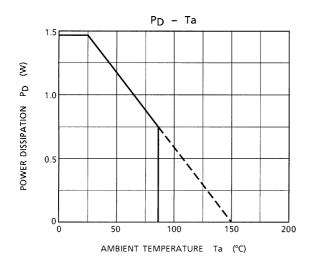
Utmost care is necessary in the design of the output line, VCC and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.







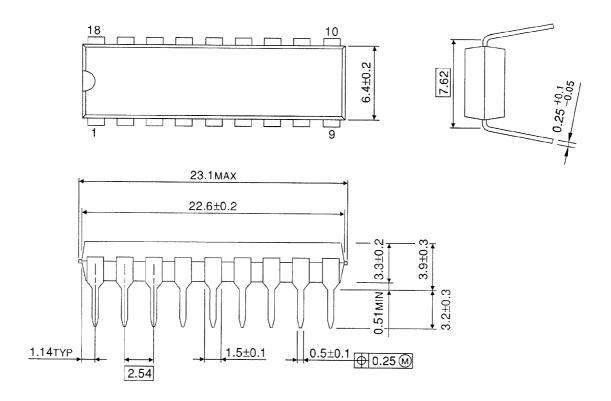




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PACKAGE DIMENSIONS

DIP18-P-300-2.54F Unit: mm



Weight: 1.478 g (Typ.)

RESTRICTIONS ON PRODUCT USE

000707EBA

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